Data Sheet

## Features

- For Base Stations applications
- Usable bandwidth 35 MHz
- Low loss
- Single-ended operation
- Ceramic Surface Mount Package (SMP)
- Small Size
- Hermetic
- RoHS compliant (2002/95/EC), Pb-free Pb



# Pin Configuration 

Surface Mount $3.00 \times 3.00 \times 1.22 \mathrm{~mm}$
SMP-12
1.22 NOM.


Dimensions shown are nominal in millimeters All tolerances are $\pm 0.15 \mathrm{~mm}$ except overall length and width $\pm 0.10 \mathrm{~mm}$

Body: $\mathrm{Al}_{2} \mathrm{O}_{3}$ ceramic
Lid: Kovar, Ni plated
Terminations: Au plating 0.5-1.0 mm , over a $2-6 \mu \mathrm{~m}$ Ni plating

## Electrical Specifications ${ }^{(1)(2)}$

Operated Temperature Range: ${ }^{(3)} \quad-30$ to $+85{ }^{\circ} \mathrm{C}$

| Parameter ${ }^{(4)}$ | Minimum | Typical ${ }^{(5)}$ | Maximum | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Center Frequency | - | 1445.4 |  | MHz |
| Maximum Insertion Loss $1427.9-1462.9 \mathrm{MHz}$ | - | 1.25 | 2.5 | dB |
| Amplitude Variation $1427.9-1462.9 \mathrm{MHz}$ $1427.9-1462.9 \mathrm{MHz} \text { (Over any } 5 \mathrm{MHz} \text { range) }$ | - | $\begin{aligned} & 0.4 \\ & 0.3 \\ & \hline \end{aligned}$ | $\begin{aligned} & 1.2 \\ & 0.8 \\ & \hline \end{aligned}$ | $\begin{aligned} & \text { dB p-p } \\ & \text { dB p-p } \end{aligned}$ |
| $\begin{aligned} & \hline \text { VSWR } \\ & 1427.9-1462.9 \mathrm{MHz} \end{aligned}$ | - | 1.7 | 2 | - |
| Phase Ripple $1427.9-1462.9 \mathrm{MHz}$ | - | 12.0 | 35 | deg |
| Absolute Delay $1427.9-1462.9 \mathrm{MHz}$ | - | 14.0 | 35 | ns |
| Group Delay Variation $1427.9-1462.9 \mathrm{MHz}$ | - | 11.0 | 30 | ns p-p |
| $\begin{gathered} \hline \text { Relative Attenuation } \\ 60-120 \mathrm{MHz} \\ 300-500 \mathrm{MHz} \\ 1240-1280 \mathrm{MHz} \\ 1390-1407.9 \mathrm{MHz} \\ 1495.9-1521 \mathrm{MHz} \\ 1600-1710 \mathrm{MHz} \\ 2140-2180 \mathrm{MHz} \\ 3200-4000 \mathrm{MHz} \\ \hline \end{gathered}$ | $\begin{gathered} 30 \\ 24 \\ 24 \\ 10 \\ 20 \\ 25 \\ 37 \\ 5 \end{gathered}$ | $\begin{gathered} 41.6 \\ 30.0 \\ 28.5 \\ 16.9 \\ 23.3 \\ 31.2 \\ 38.8 \\ 8.3 \\ \hline \end{gathered}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ $\mathrm{dB}$ |
| Source Impedance (single-ended) ${ }^{(7)}$ Load Impedance (single-ended) | - | $\begin{aligned} & 50 \\ & 50 \\ & \hline \end{aligned}$ | - | $\begin{aligned} & \Omega \\ & \Omega \\ & \hline \end{aligned}$ |

## Notes:

1. All target specifications are based on TriQuint test circuit shown below
2. All target specifications represent a design goal and not a guarantee until the design is finalized and a datasheet is issued
3. In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature
4. Electrical margin has been built into the design to account for the variations due to temperature drift and manufacturing tolerances
5. Typical values are based on average measurements at room temperature
6. Attenuation relative to Maximum Insertion Loss
7. This is the optimum impedance In order to achieve the performance shown

## Test Circuit:

Actual matching values may vary due to PCB layout and parasitics
$50 \Omega$
Single-ended Input

$50 \Omega$
Single-ended Output

SEMICONDUCTOR

## Typical Performance (at $+25^{\circ} \mathrm{C}$ )



Wideband Response


Input Smith Chart


Passband Response



Output Smith Chart


## Matching Schematics

Actual matching values may vary due to PCB layout and parasitics
$50 \Omega$
Single-ended Input

$50 \Omega$
Single-ended Output

## Marking

The date code consists of: day of the current year (Julian, 3 digits), $\mathrm{Y}=$ last digit of the year and $\mathrm{M}=$ manufacturing site code

## PCB Footprint



This footprint represents a recommendation only Dimensions shown are nominal in millimeters


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Data Sheet

| Maximum Ratings |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: |
| Parameter | Symbol | Minimum | Maximum | Unit |
| Operating Temperature Range | T | -30 | +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {sta }}$ | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |
| Input Power ${ }^{(1)}$ | $\mathrm{P}_{\text {in }}$ | - | +22 | dBm |

Note:

1. Input Power is targeted for an applied CW modulated RF signal at $55^{\circ} \mathrm{C}$ for 125 hours

## Important Notes

## Warnings

- Electrostatic Sensitive Device (ESD)
- Avoid ultrasonic exposure


## RoHS Compliance

- This product complies with EU directive 2002/95/EC (RoHS)

Solderability

- Compatible with JEDEC J-STD-020C Pb-free process, $260^{\circ} \mathrm{C}$ peak reflow temperature


## Links to Additional Technical Information

PCB Layout Tips
Qualification Flowchart
Soldering Profile
S-Parameters
RoHS Information
Other Technical Information

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